

# Meteor Lake Architecture Overview

# Advancing Moore's Law

## 5 NODES IN 4 YEARS



Intel  
7

In High Volume Manufacturing **Today**



Intel  
4

Ramping Production **Today**

Intel  
3

Manufacturing Ready **H2 2023**

Intel  
20A


Manufacturing Ready **H1 2024**

Intel  
18A

Manufacturing Ready **H2 2024**



# Meteor Lake Pillars



Build our most **power-efficient** client processor in history

Deliver **AI at Scale**

First client integration of AI engine (NPU)

Leap in **graphics** performance  
With increased power efficiency

Launch IA on **Intel 4**

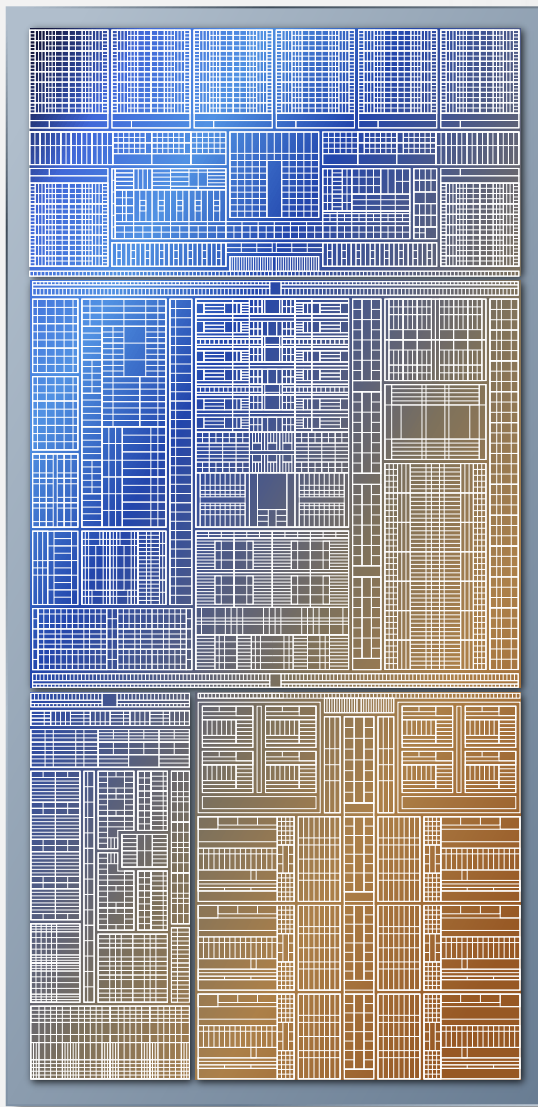
First Intel 4 P-core (Redwood Cove) & E-core (Crestmont)



INTRODUCING

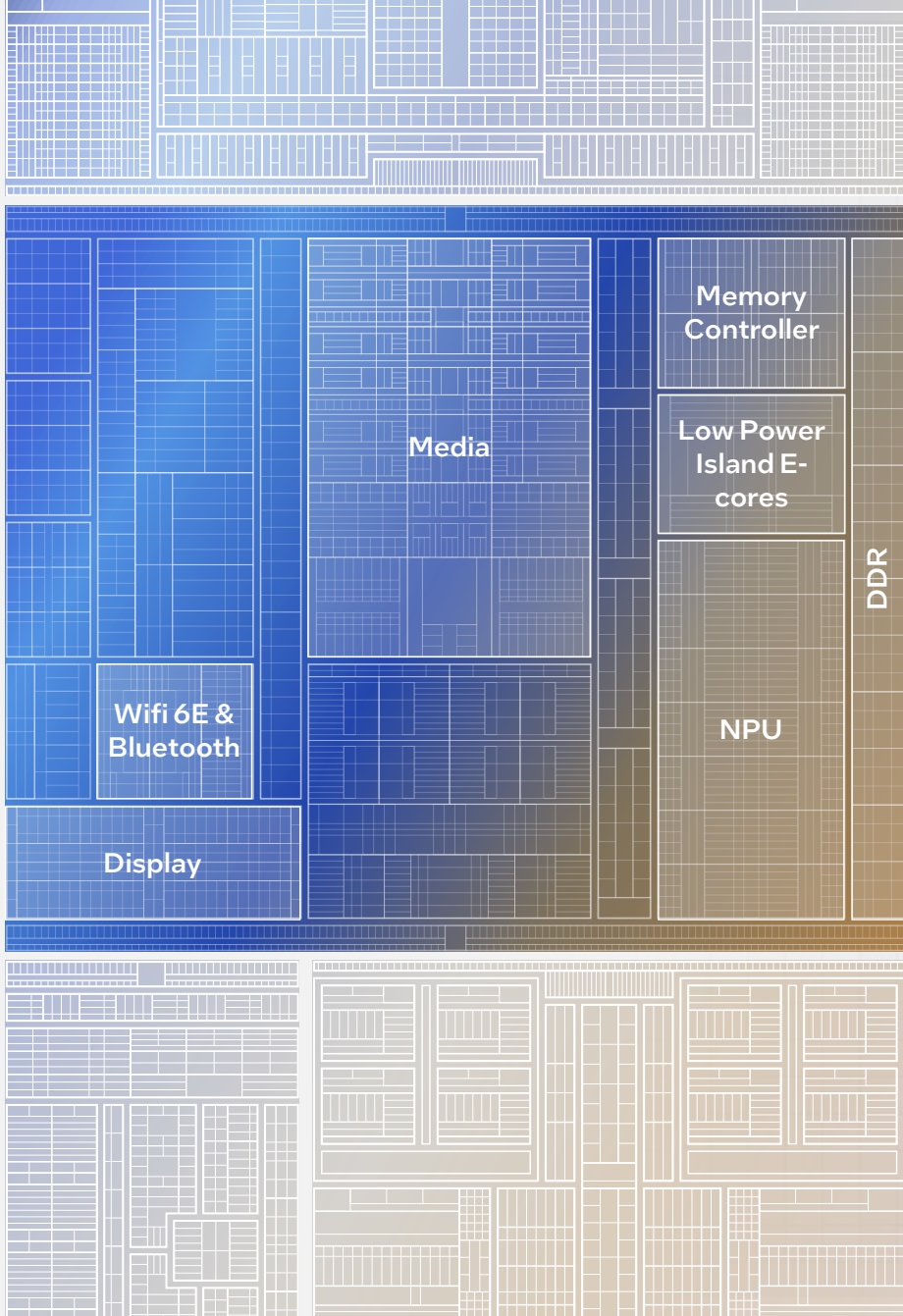
# Meteor Lake





INTRODUCING

# Meteor Lake



# SOC Tile

New **low power island** E-cores

First built-In **NPU AI Engine**

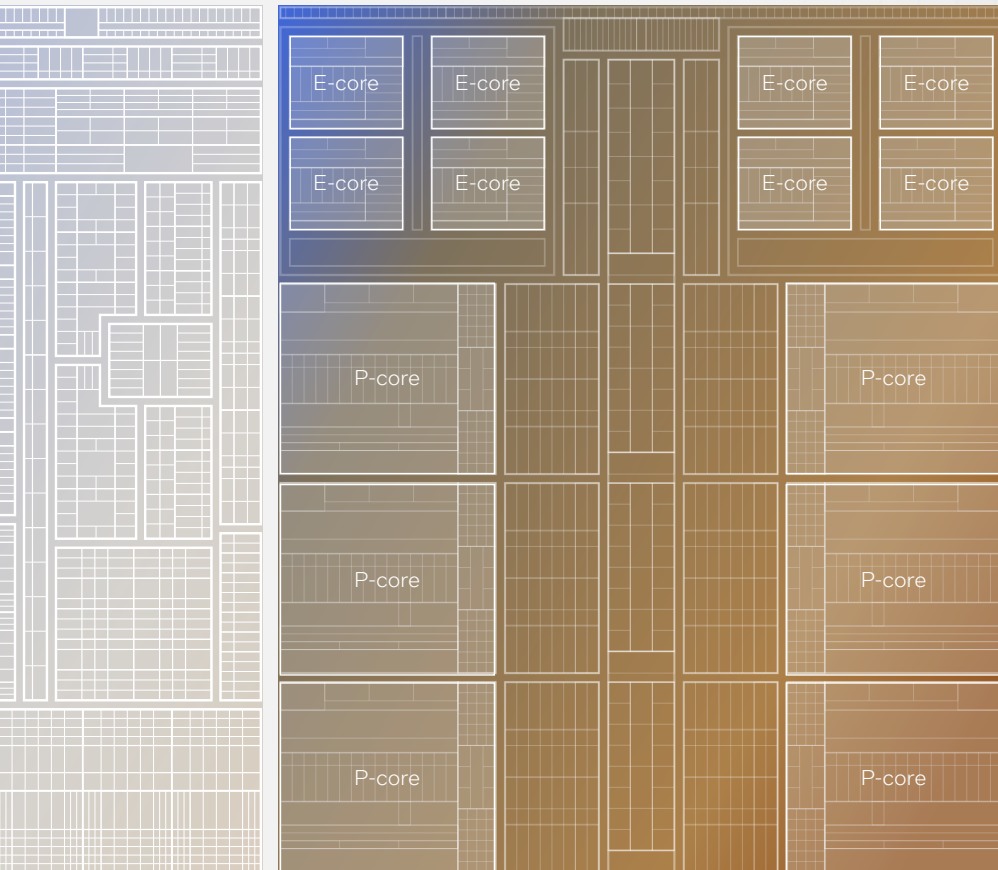
Leading **Wi-Fi 6E & Wi-Fi 7** support

**8K HDR & leading AV1** support

Native **HDMI 2.1 and DP 2.1** standards

Integrated **memory controller & DDR**

# Compute Tile

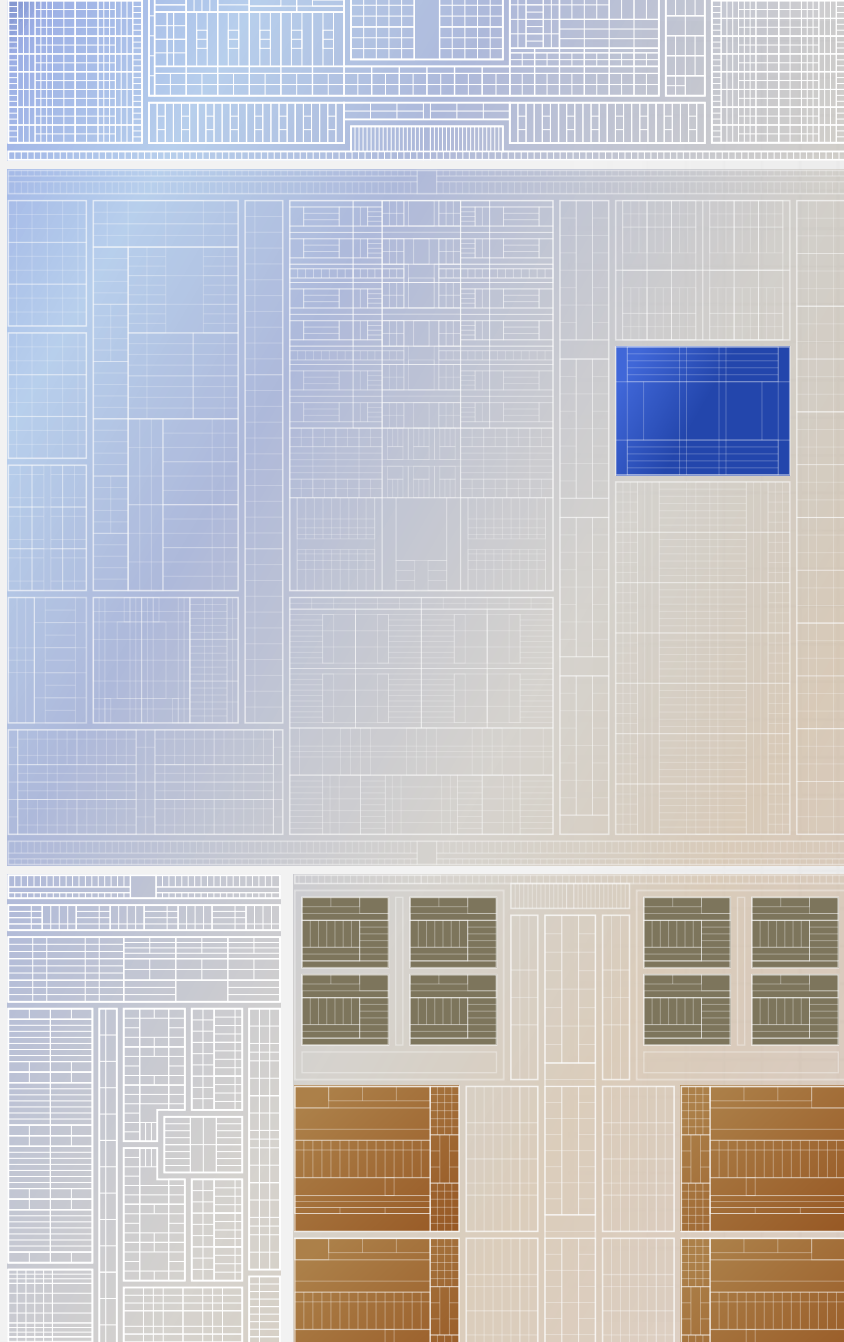


New **E-core** microarchitecture

New **P-core** microarchitecture

First on **Intel 4** process technology





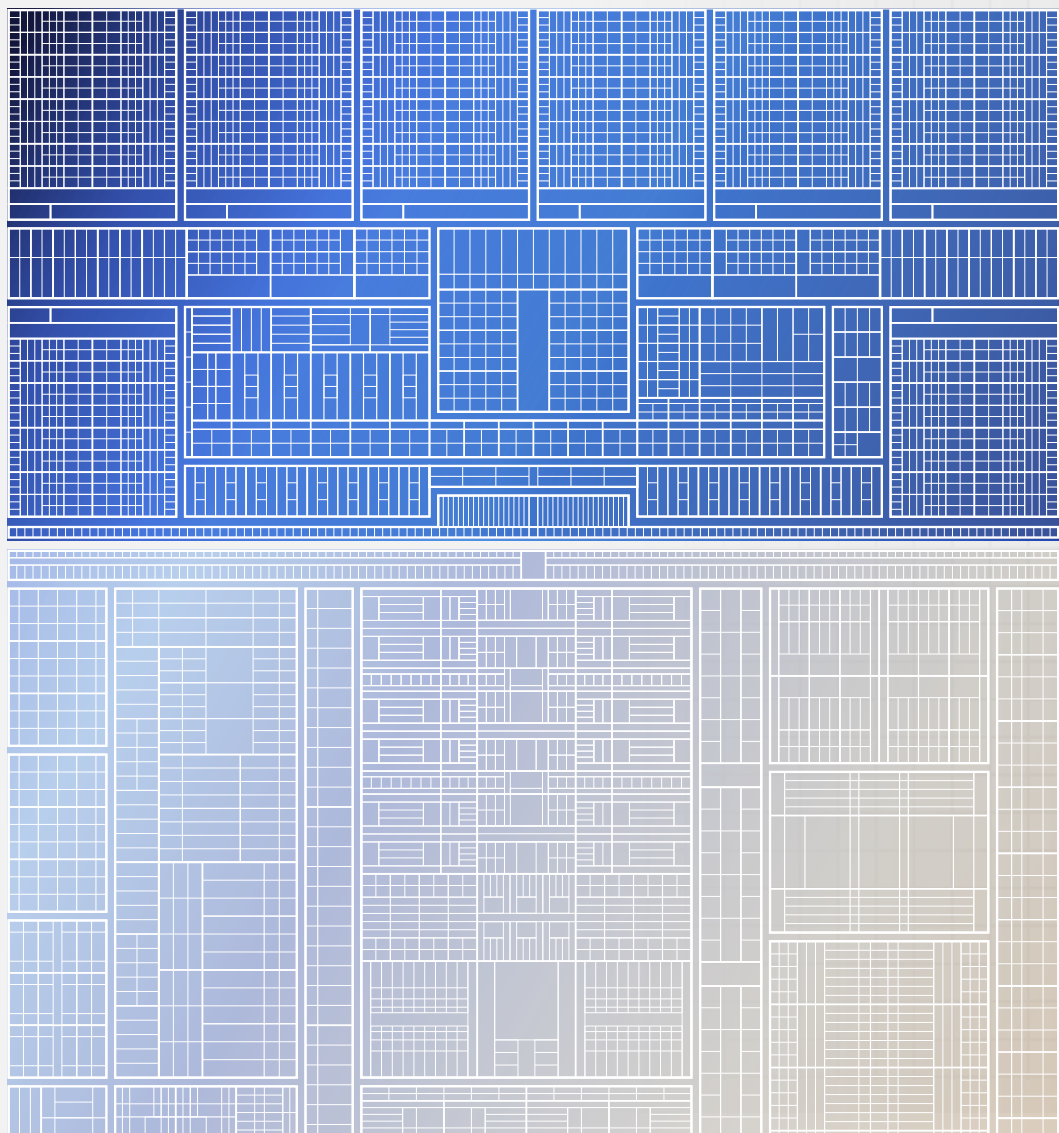
Low  
Power  
E-core

E-core

P-core

# 3D

## performance hybrid architecture

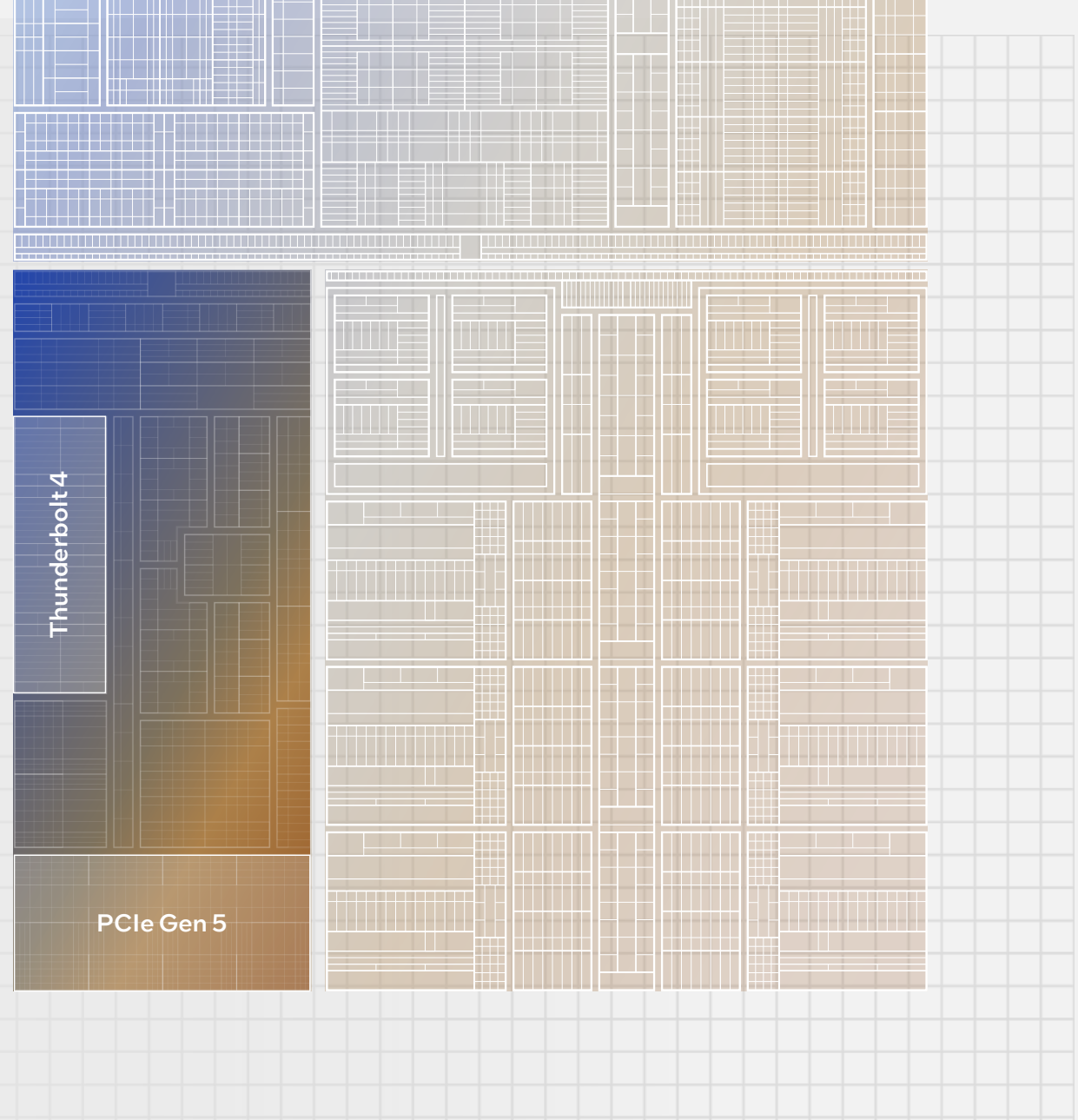


# intel.<sup>®</sup> ARC<sup>™</sup> Graphics

Intel<sup>®</sup> Arc<sup>™</sup> graphics only available on select MTL processor-powered systems with dual-channel memory.

# IO Tile

Industry leading connectivity with  
integrated **Thunderbolt 4**  
& **PCIe Gen5**





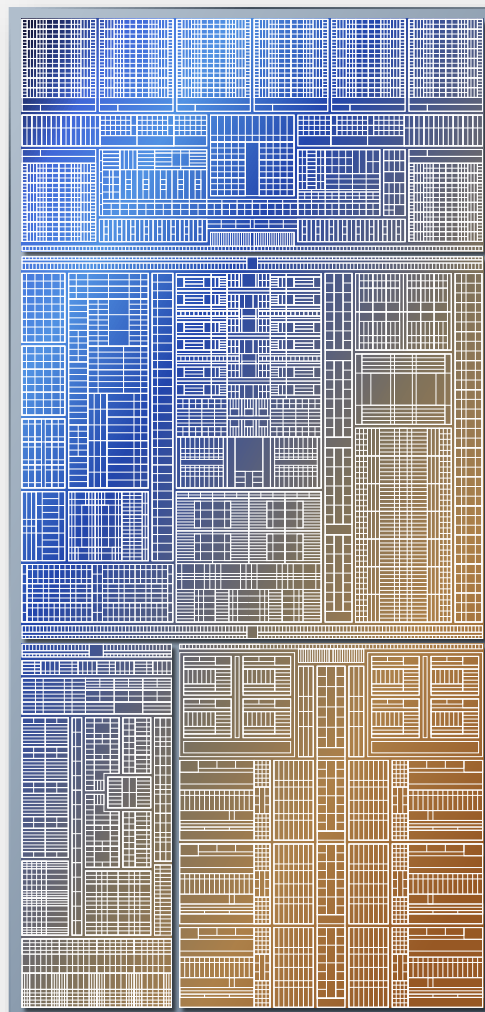
# Meteor Lake

Industry leading **Wi-Fi 6E & Wi-Fi 7** support

Industry leading **FOVEROS 3D** packaging

Industry leading **Thunderbolt 4**

Latest connectivity **PCIe Gen5**



**New** Intel Arc graphics

**New** Media & Display standards

**New** Low power island E-cores

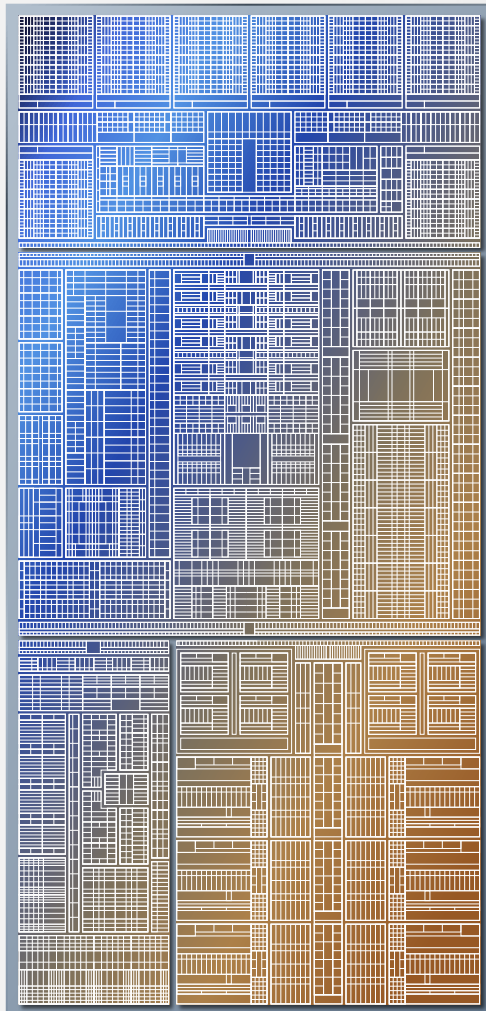
**First** Built-In NPU AI engine

**First** 3D performance hybrid architecture

**New** P-core & E-core microarchitectures

**First** on Intel 4 process technology

## Intel's largest client SoC architectural shift in 40 years



Industry leading  
**FOVEROS 3D**  
packaging

# Next-gen Uncore Guiding Principles

Repartition compute intensive IPs  
for **power optimization**

1

Enable IO bandwidth  
**scalability**

2

Extend hybrid architecture with the  
addition of **low power IA cores**

3

Re-construct  
**power management**

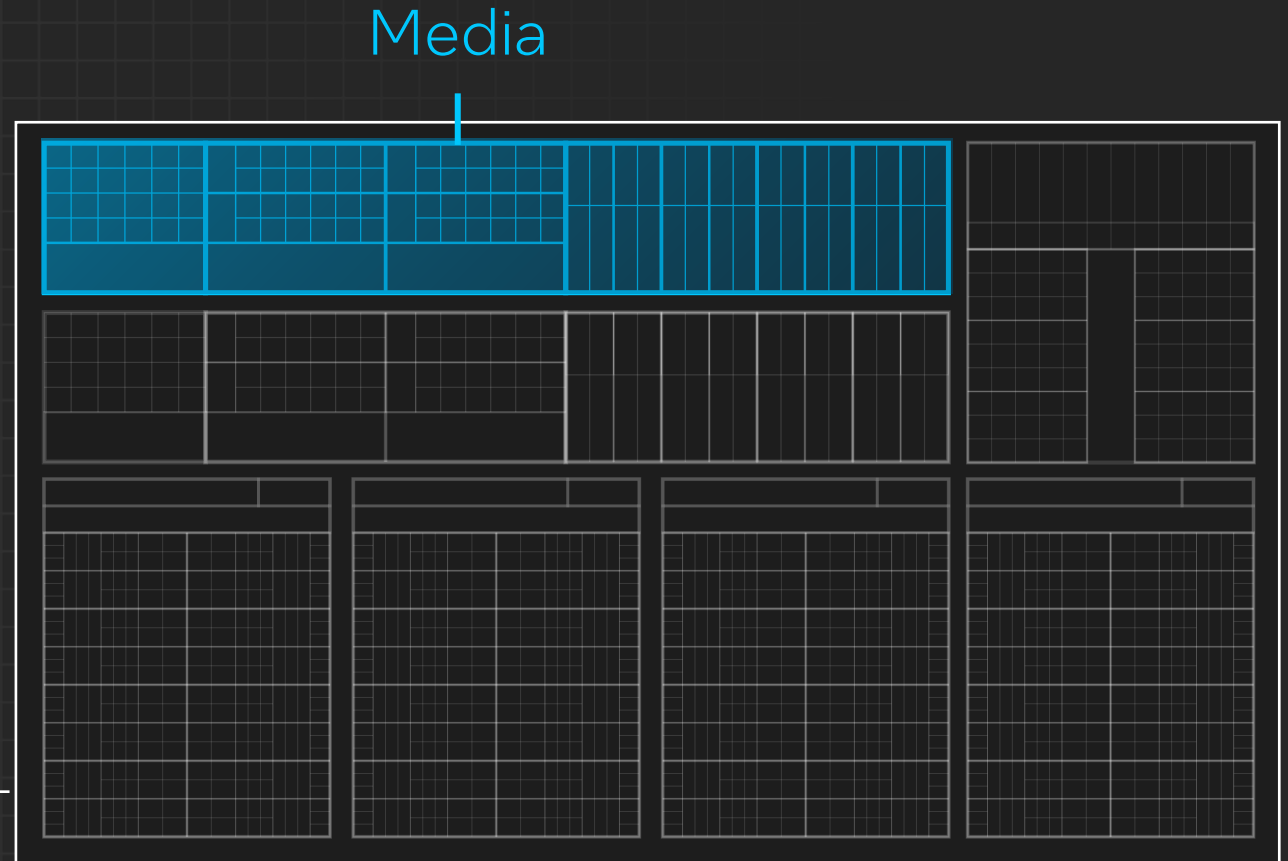
4



# Repartition Compute Intensive IP

Media IP is embedded in graphics IP

Graphics  
Complex

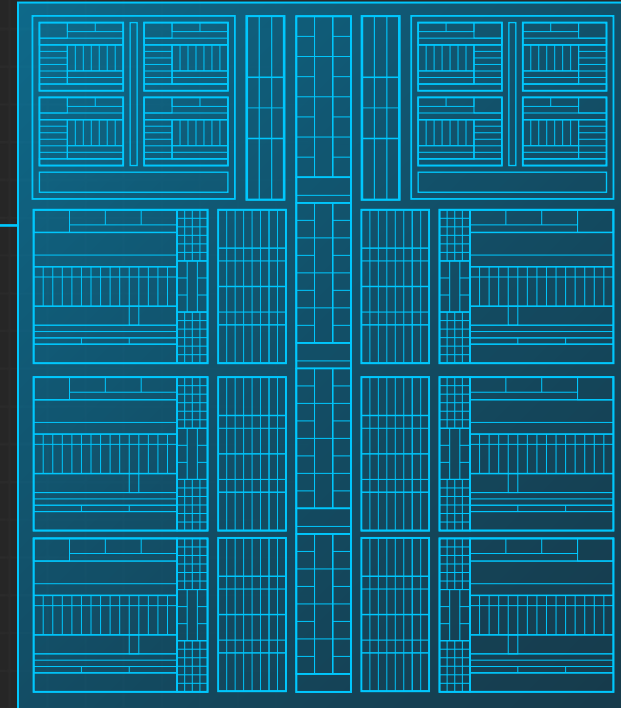


# Repartition Compute Intensive IP

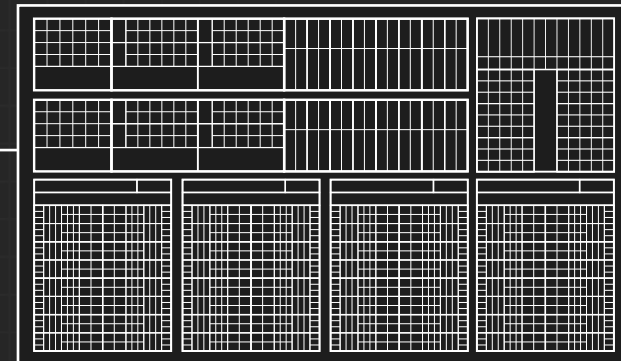
Media IP is embedded in graphics IP

Graphics attached to core complex

Core  
Complex



Graphics  
Complex



# Repartition Compute Intensive IP

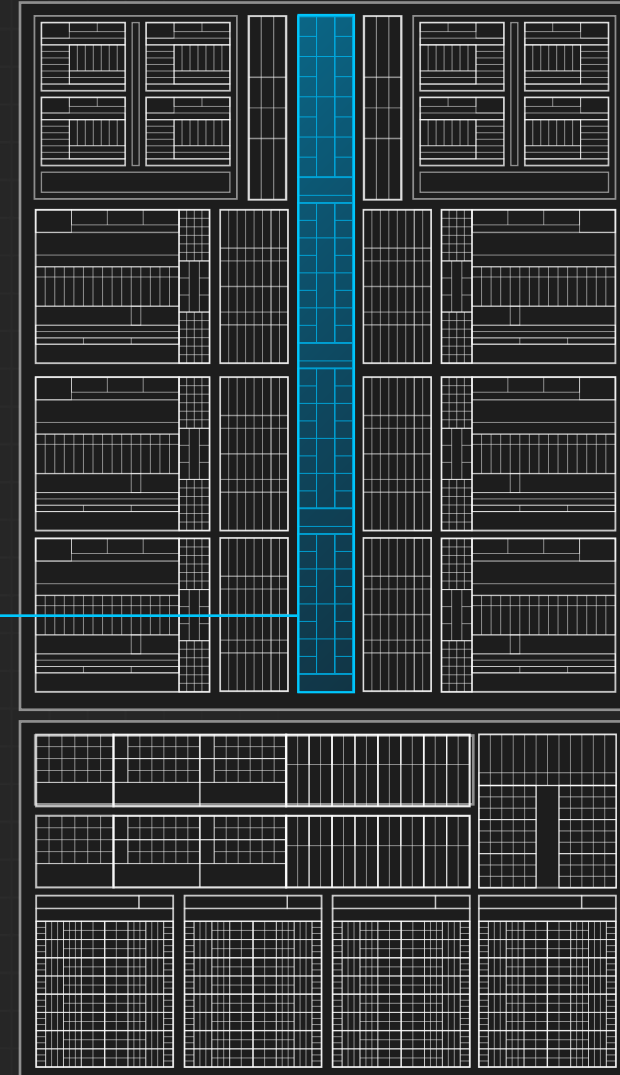
Media IP is embedded in graphics IP

Graphics attached to core complex

All use same ring fabric

Ring fabric only way to access mem

Ring Fabric





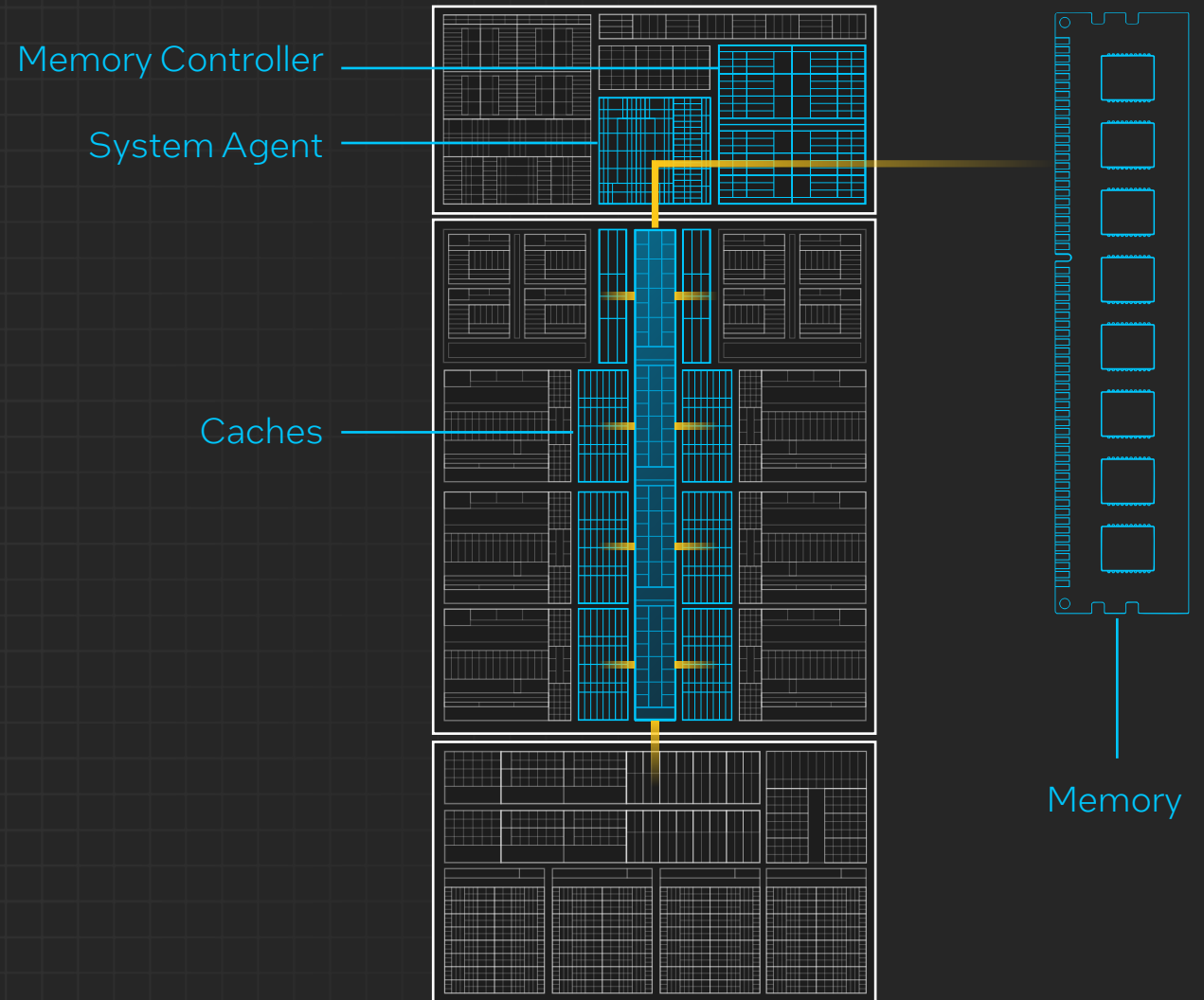
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Graphics attached to core complex

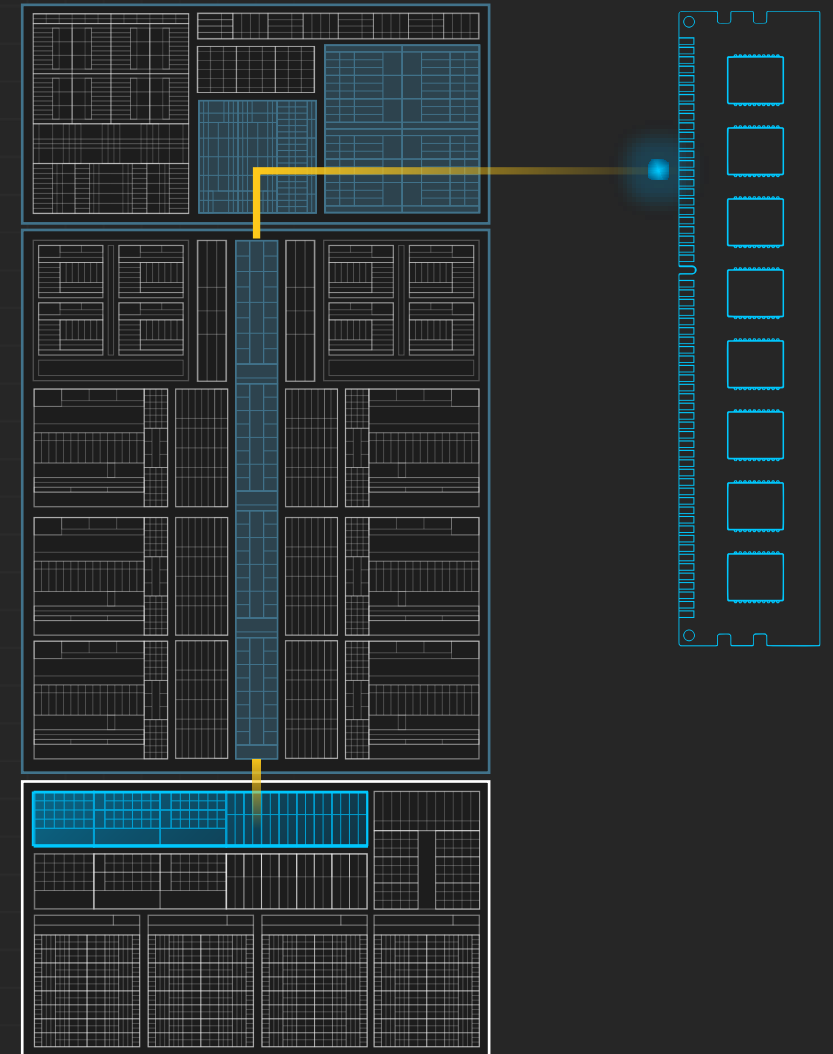
All use same ring fabric

Only way to access mem & cache



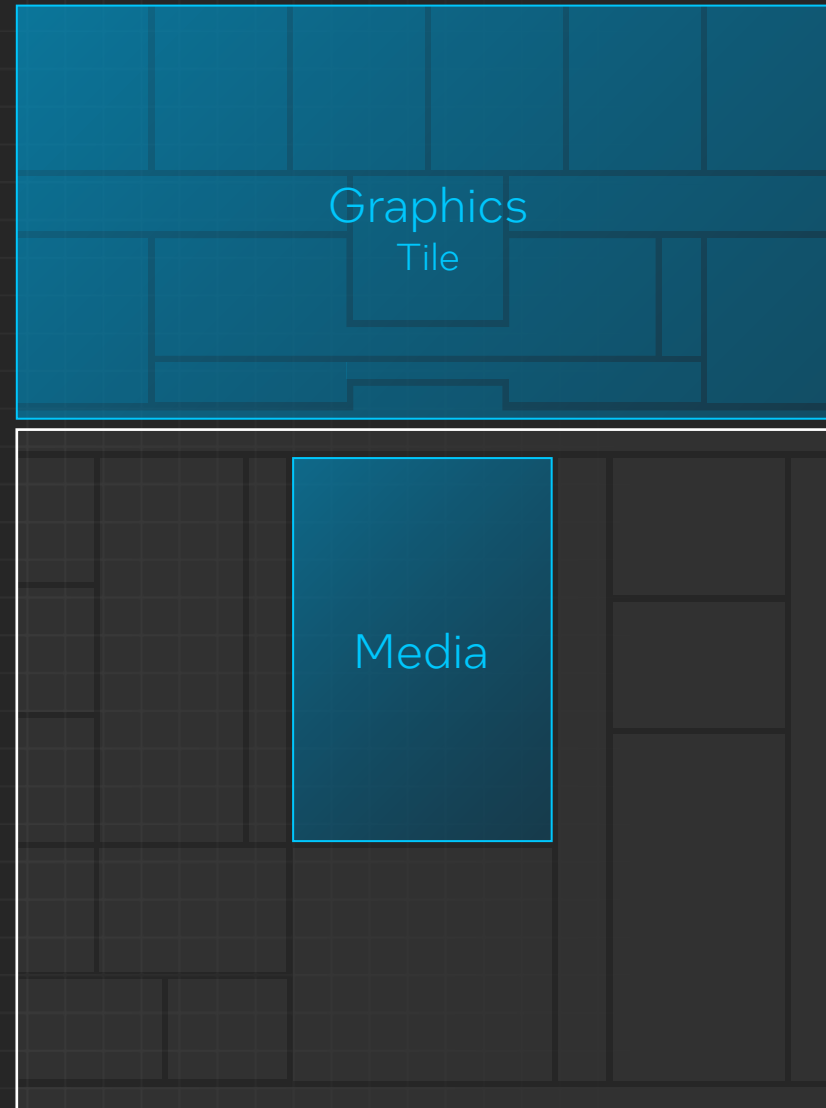
# Repartition Compute Intensive IP

Core complex stays on if either graphics or media need to access memory



# Compute Intensive IP in Meteor Lake

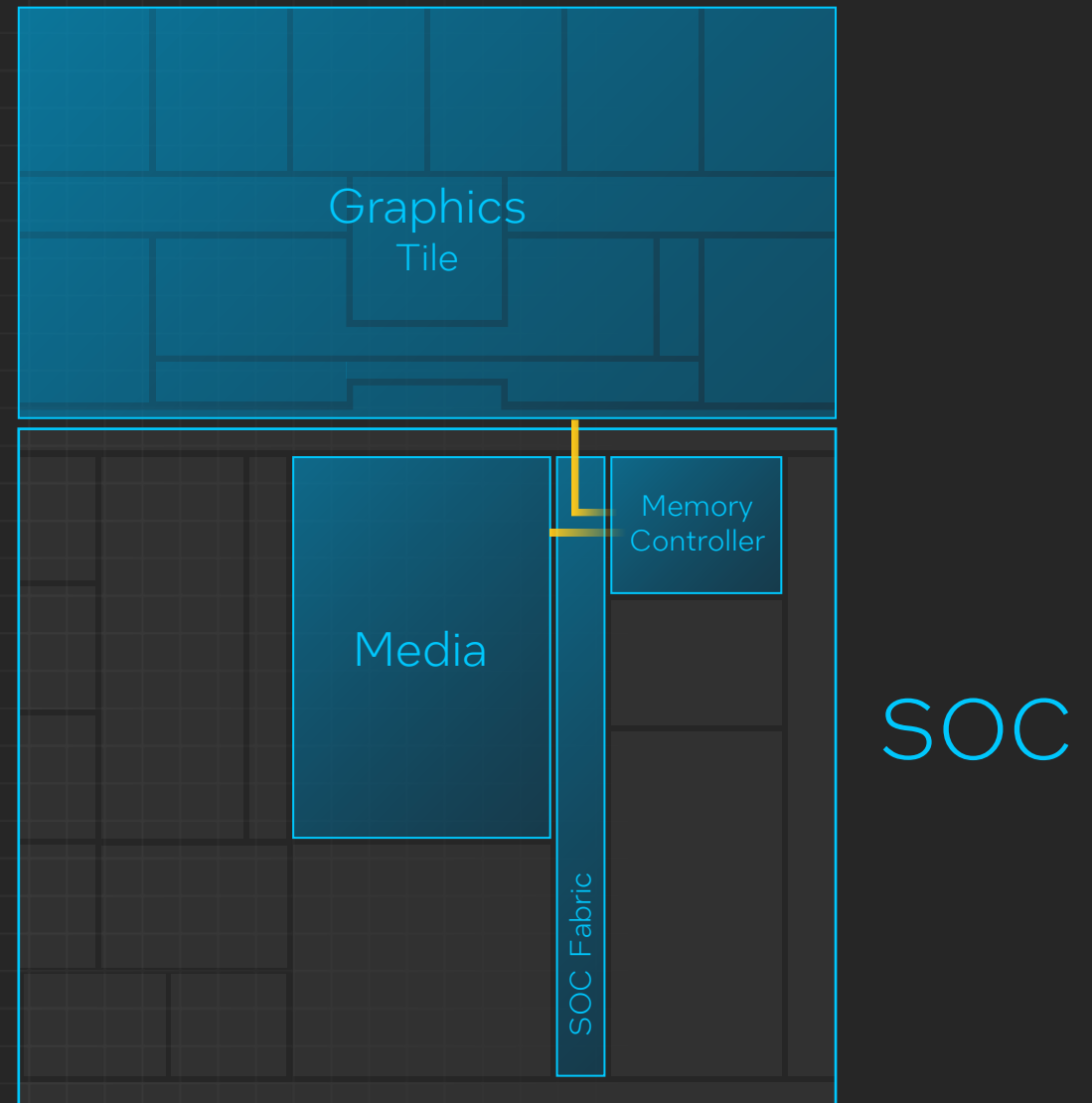
Media separated from graphics



# Compute Intensive IP in Meteor Lake

Media separated from graphics

Both independently attached to SOC



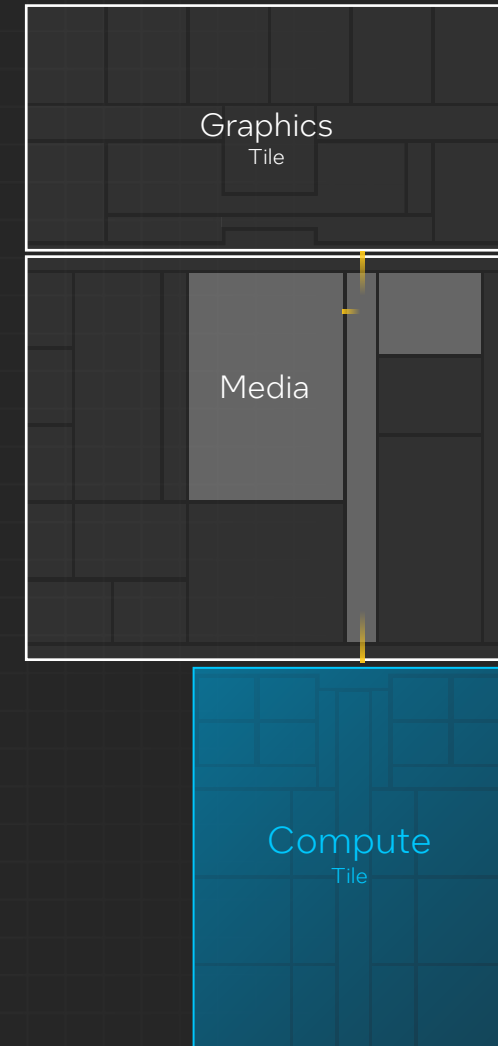


# Compute Intensive IP in Meteor Lake

Media separated from graphics

Both independently attached to SOC

Independent core complex



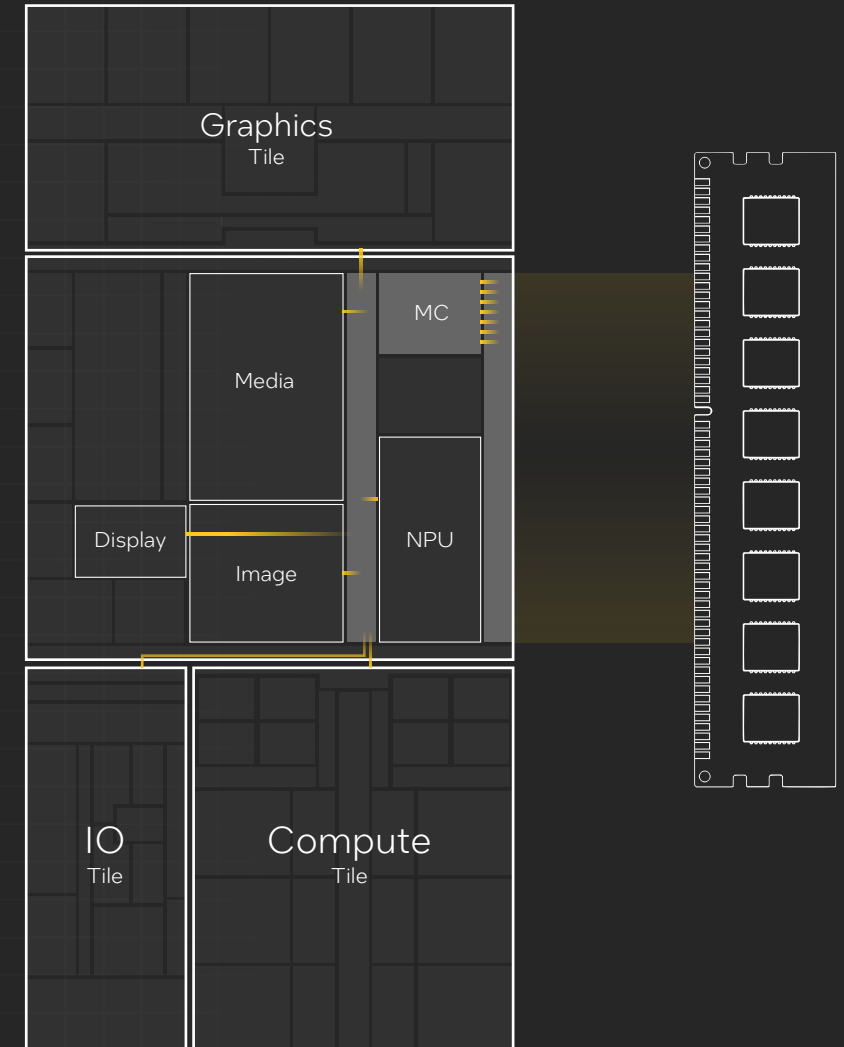
# Compute Intensive IP in Meteor Lake

Media separated from graphics

Both independently attached to SOC

Independent core complex

All IPs have independent paths to memory



# Compute Intensive IP in Meteor Lake

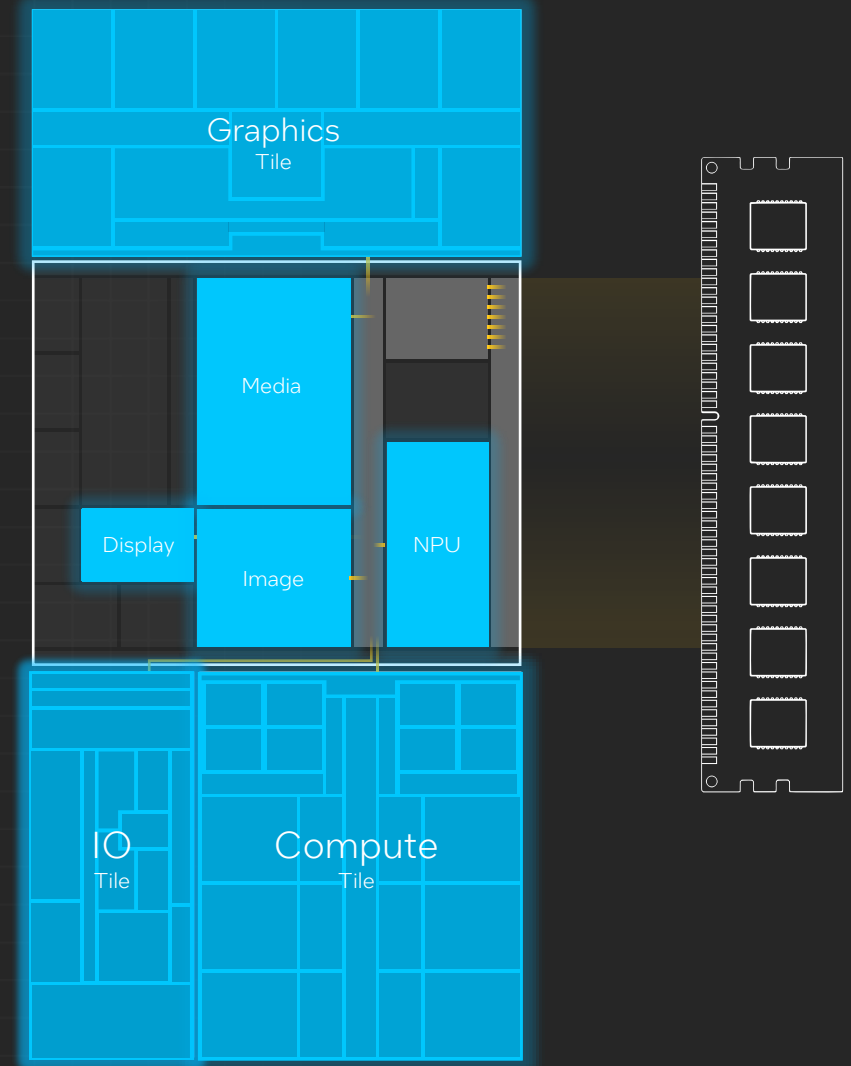
Media separated from graphics

Both independently attached to SOC

Independent core complex

All IPs have independent paths to memory

All IPs can be independently powered on/off



# Compute Intensive IP in Meteor Lake

Media separated from graphics

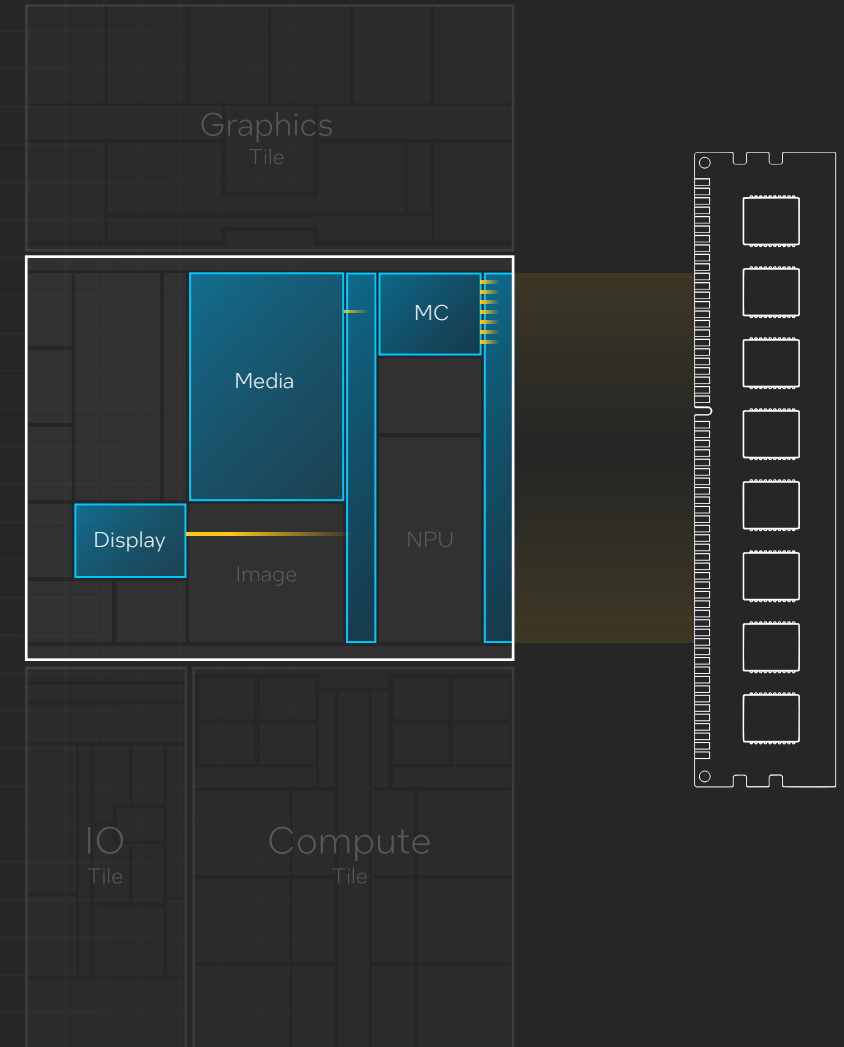
Both independently attached to SOC

Independent core complex

All IPs have independent paths to memory

All IPs can be independently powered on/off

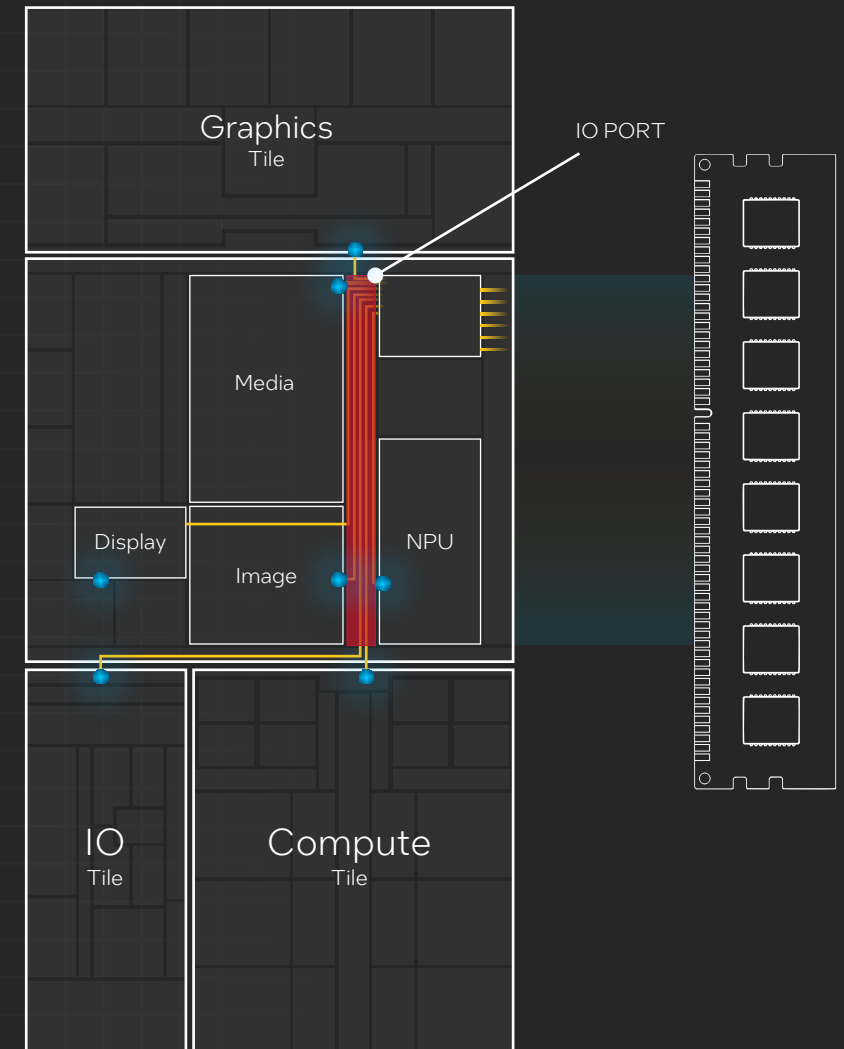
**media playback**



# I/O Bandwidth Scalability

Media/Graphics/NPU/IO tile add significant traffic

IO Port now critical bottleneck





# I/O Bandwidth Scalability

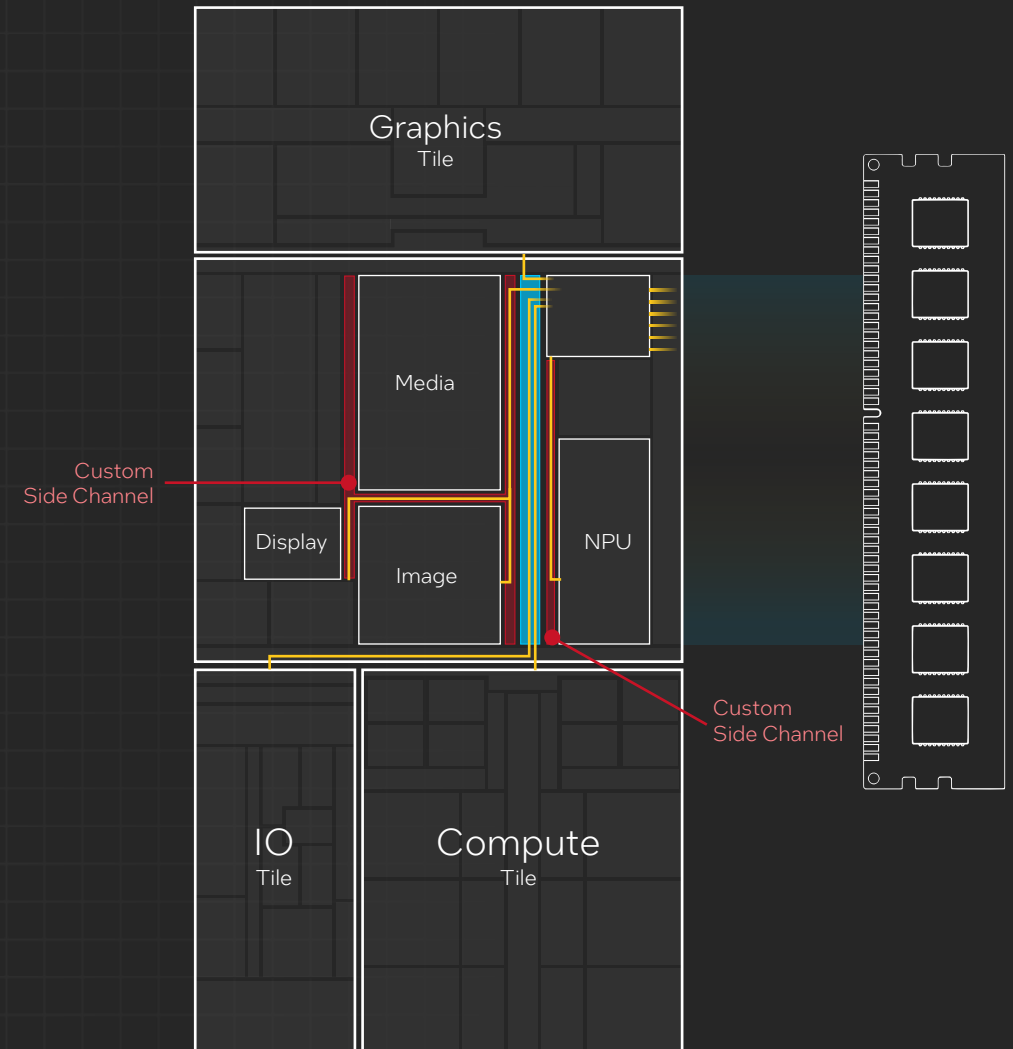
Media/Graphics/NPU/IO tile add significant traffic

IO Port now critical bottleneck

## SOLUTION #1

Custom side channels for each IP

Not scalable



# I/O Bandwidth Scalability

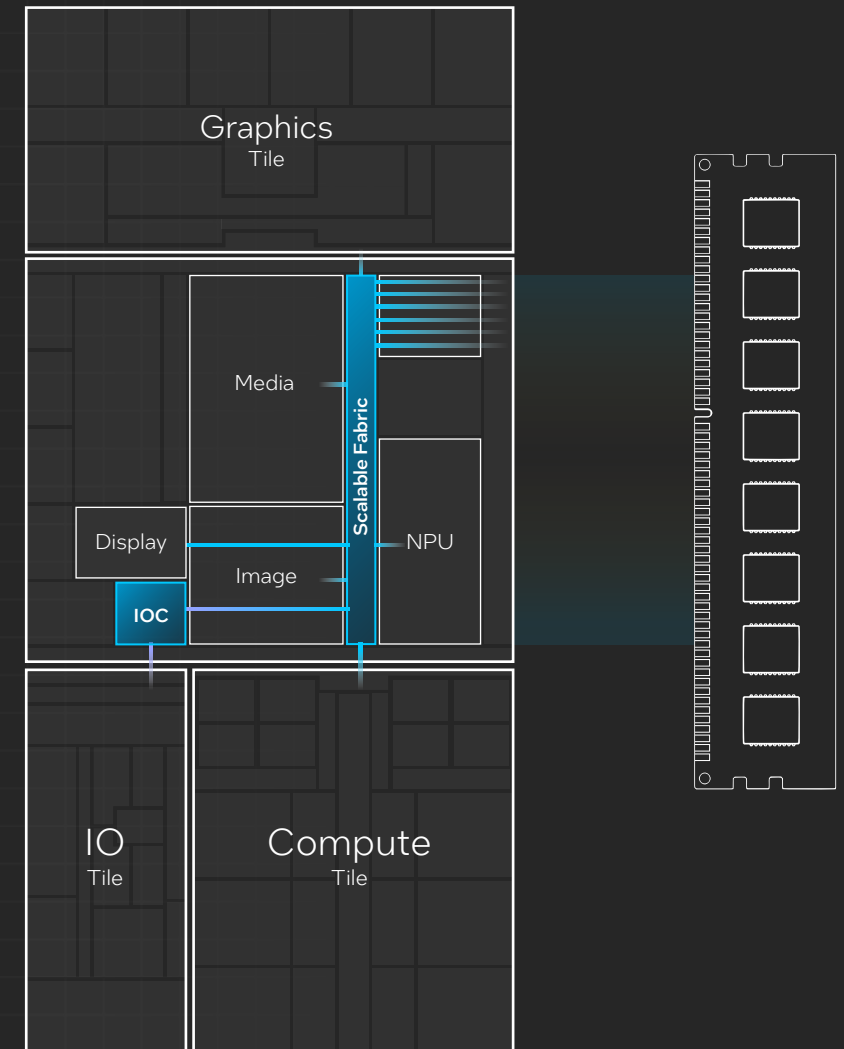
Media/Graphics/NPU/IO tile add significant traffic

IO Port now critical bottleneck

## CHOSEN SOLUTION

New Scalable Fabric for high BW (128 GBs) connectivity

All IO ordering and address translation goes through IOC

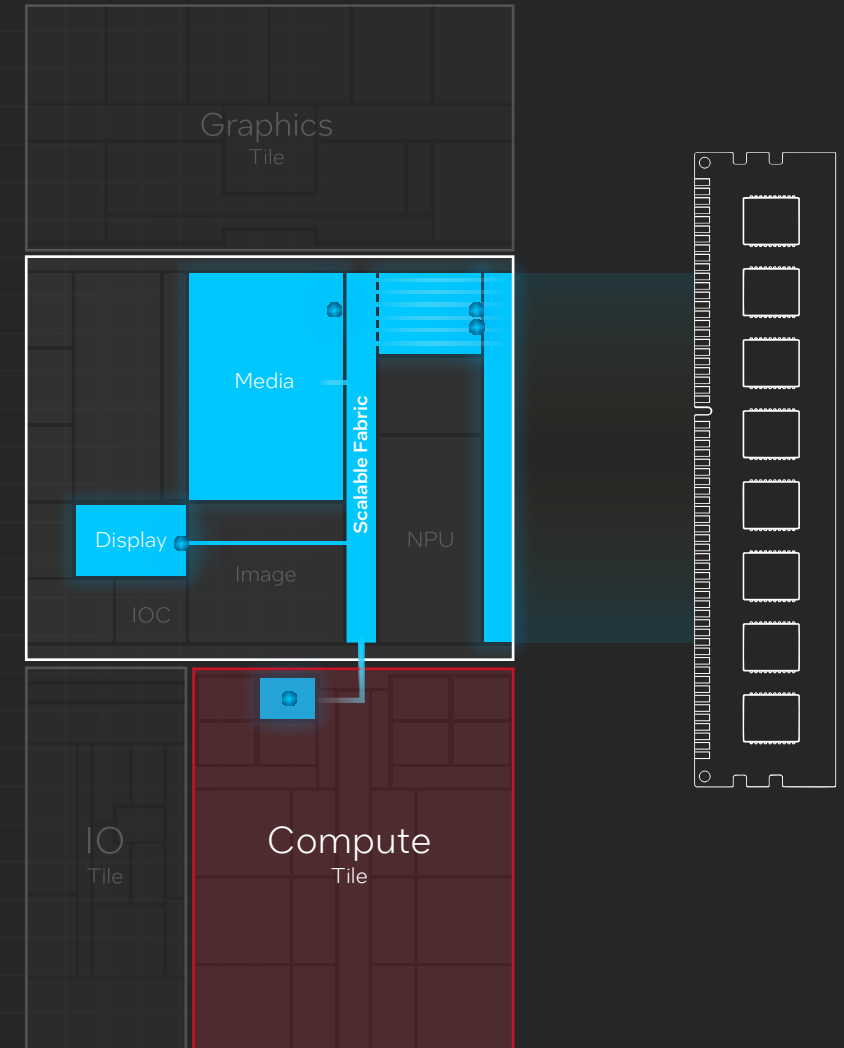


# Next Evolution of Our Hybrid Architecture

## OPPORTUNITY

IA complex is **woken** up even for low compute intensity workloads

# 3



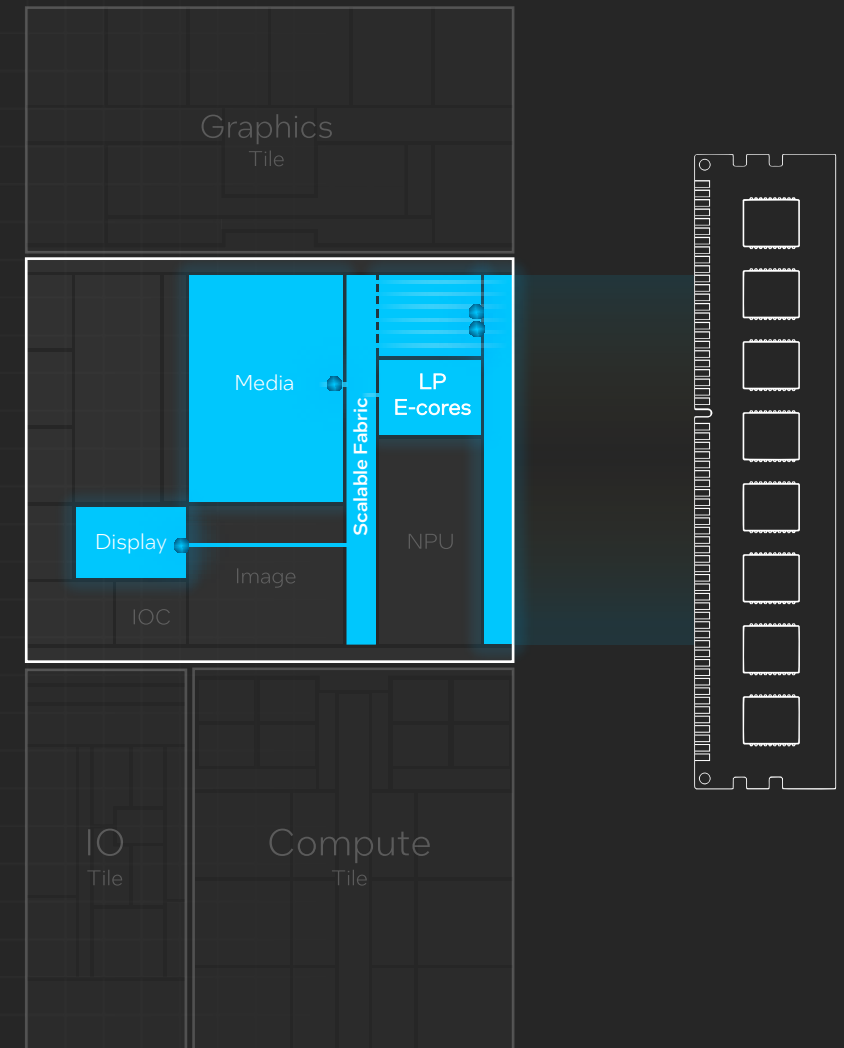
# Next Evolution of Our Hybrid Architecture

## OPPORTUNITY

IA complex **are woken** up even for low compute intensity workloads

## SOLUTION

Lower power E-cores on SOC



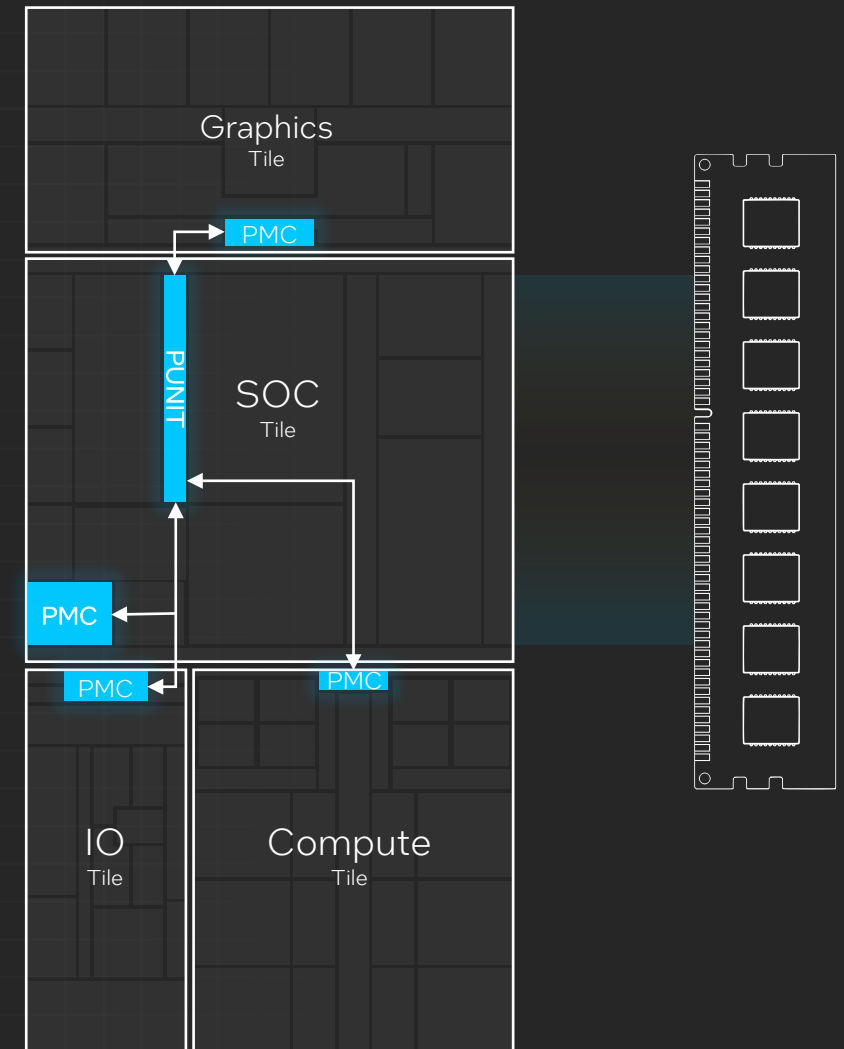
# Re-constructing Power Management

Grounds up **modular and scalable PM** architecture for disaggregation

New **scalable fabric** for improved bandwidth and energy efficiency

Coordination between **multiple PM controllers** on different tiles

Coordination between SOC PM controllers and system software





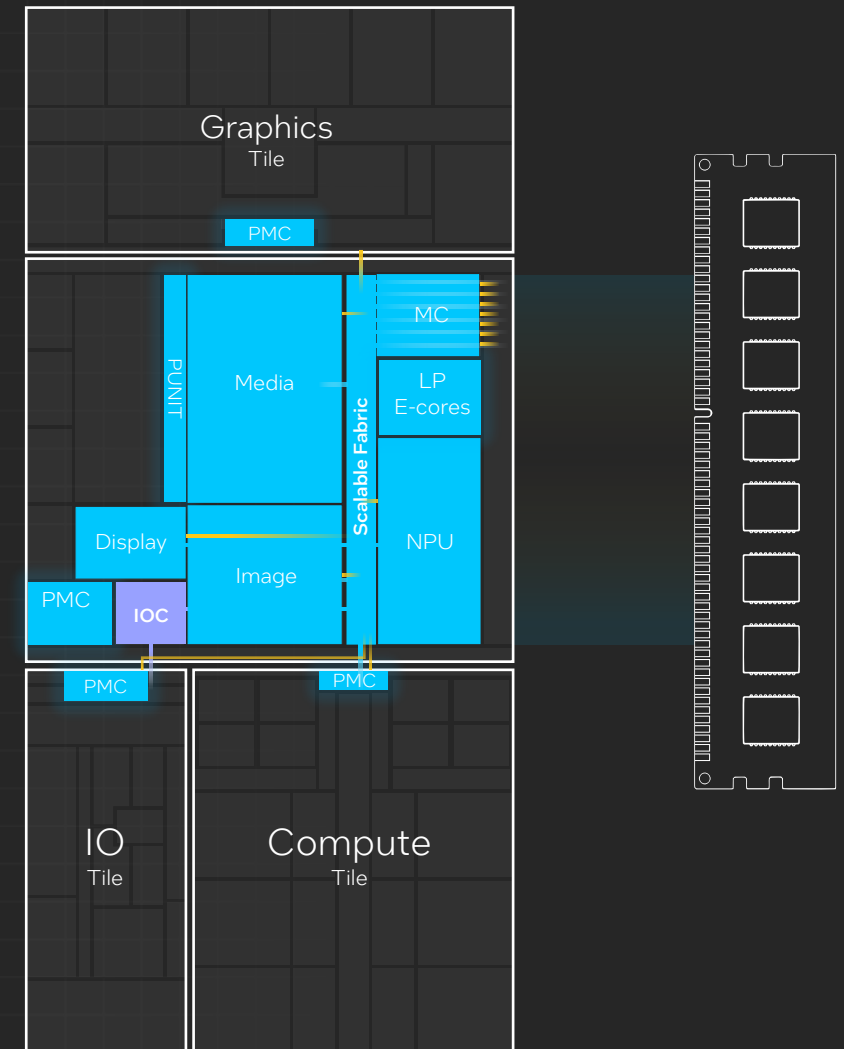
# Next-gen Uncore Guiding Principles

1 Repartition compute intensive IPs for **power optimization**

2 Enable IO bandwidth **scalability**

3 Re-design of hybrid architecture with the addition of **low power IA cores**

4 Re-construct **Power Management**







# New Architectural Capabilities



# AI is Everywhere



INTRODUCING

# Intel's First Integrated NPU

Dedicated AI Engine for Low Power Inference

Purpose built for  
efficient client AI

Ideal for sustained  
AI and AI offload

Standardized  
program interfaces





# New AI PC Era Powered By Meteor Lake

GPU

## Performance Parallelism & Throughput

Ideal for AI infused in  
Media/3D/render pipeline

NPU

## Dedicated Low Power AI Engine

Ideal for sustained AI and AI offload

CPU

## Fast Response

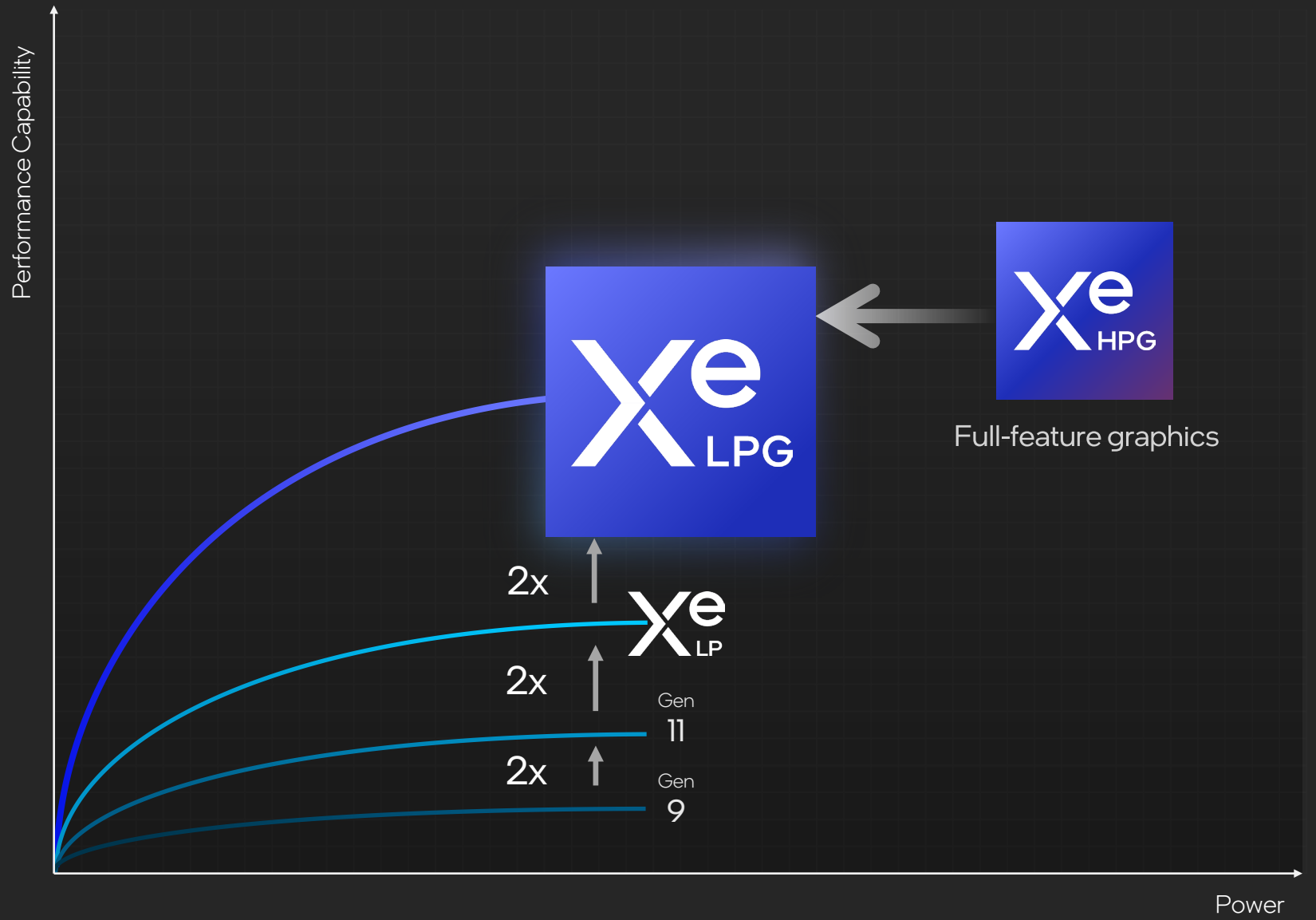
Ideal for light-weight,  
single inference low-latency AI tasks



# Xe LPG

## Graphics IP

Scaling the graphics engine



\*See appendix for workloads and configurations. Results may vary.

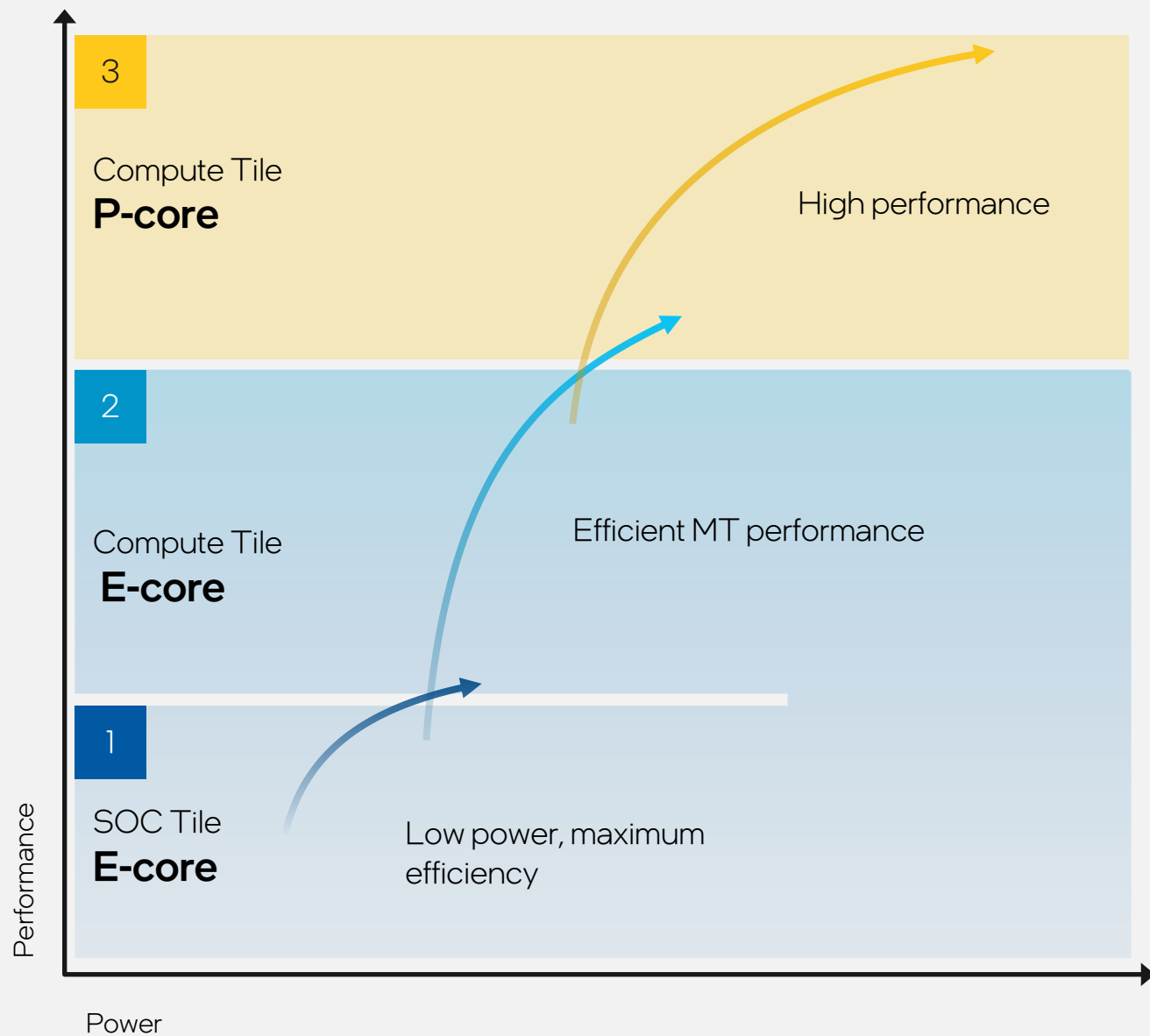
# Meteor Lake GPU



\*Compared to prior generation. See appendix for more information. Results may vary.

\*\*Intel® Arc™ graphics only available on select MTL processor-powered systems with dual-channel memory.

# 3D Performance Hybrid Architecture



\*Conceptual representation of 3D Perf Hybrid Arch



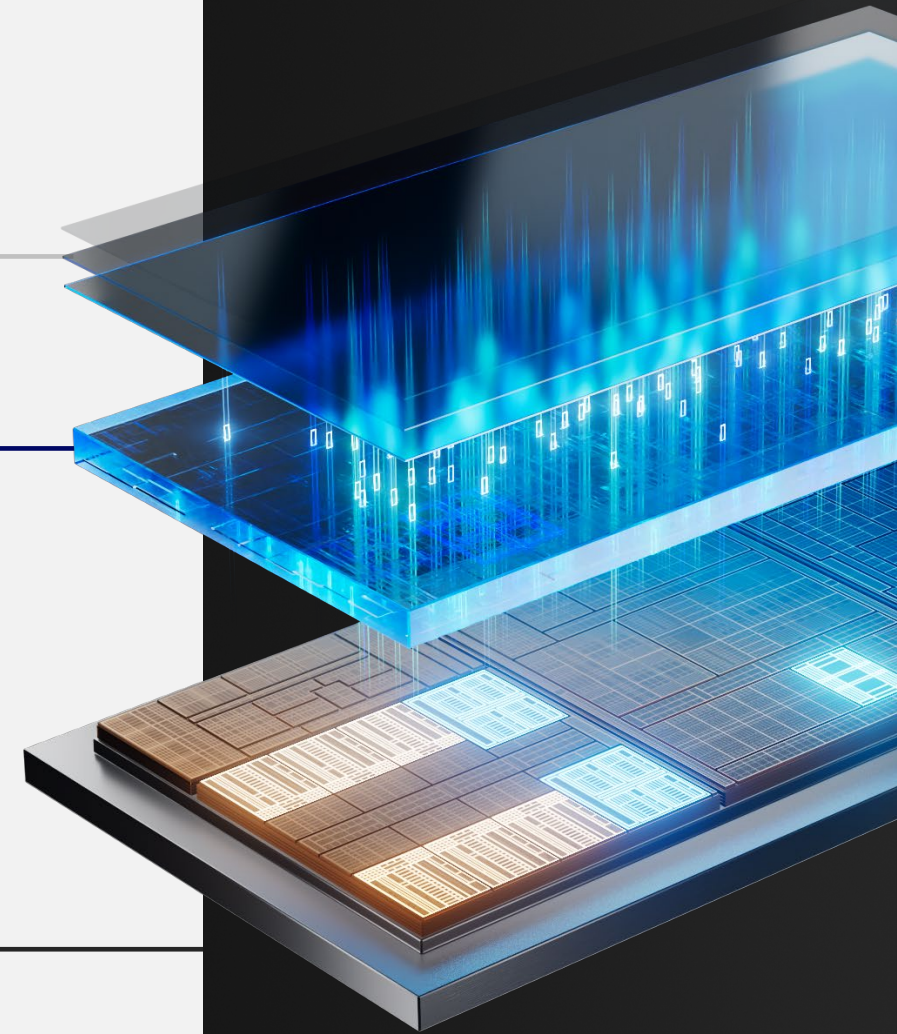
INTEL THREAD DIRECTOR

# Architecture

OS Scheduler

Intel Thread Director

E-cores & P-cores







# Leveraging Disaggregation



# Leveraging

# Disaggregation

**"Experience First" Client**  
drives New Era of System level integration



# Leveraging

# Disaggregation

**"Experience First" Client**  
drives New Era of System level integration

**Process, packaging & architecture**  
together make this possible



# Leveraging

# Disaggregation

**"Experience first" client**  
drives new era of system-level integration

**Process, packaging & architecture**  
together make this possible

**Extremely flexible architecture**  
that scales across design points and time

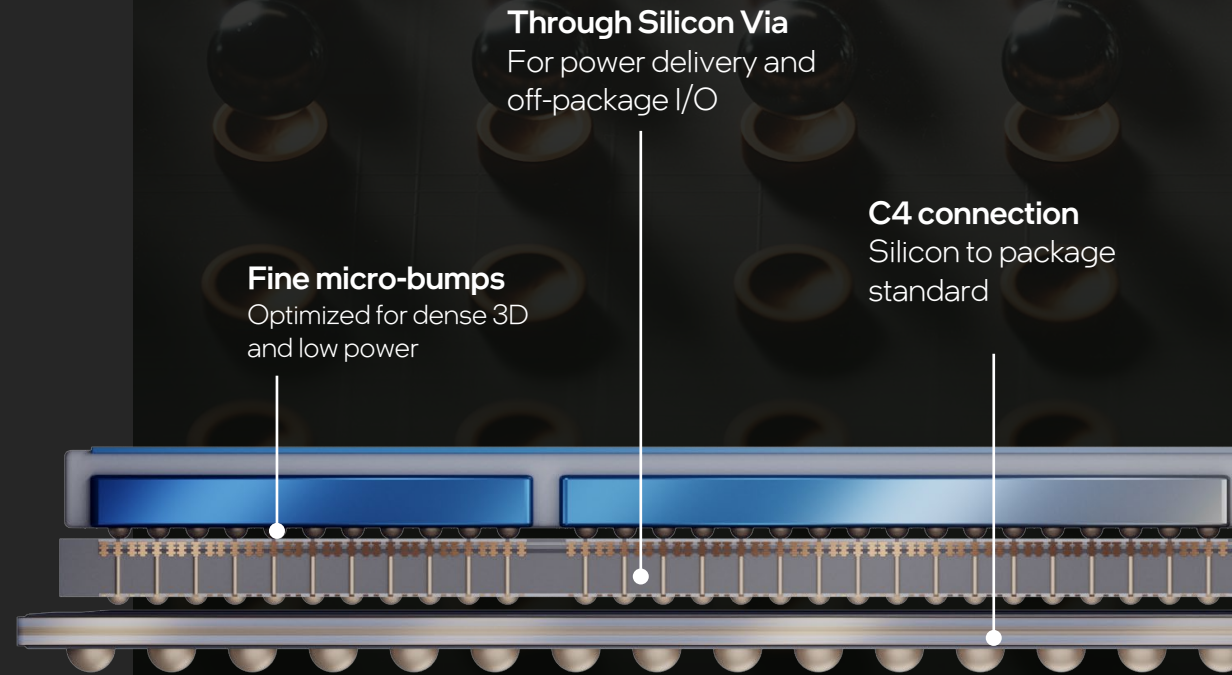


# FOVEROS TECHNOLOGY ADVANTAGE

**High  
Density**  
Wires / Area

**Energy  
Efficient**  
 $\mu\text{J} / \text{Bit}$

**Low  
Latency**  
Nanosecond / trip



Introducing

# Intel 4

Logic process technology

**2x**

**area scaling**

for High Perf Logic  
library vs Intel 7\*

**EUV**

lithography for  
process  
simplification

**>20%**


power efficiency vs  
Intel 7\*

Compatible with  
**3D Foveros**

Advanced  
Packaging



\*Based on internal estimates.  
Learn more at [www.intel.com/PerformanceIndex](http://www.intel.com/PerformanceIndex).  
Results may vary.



# Meteor Lake

**Most power-efficient processor we've ever built**

Build our most  
**power-efficient**

client processor in history



Launch IA on **Intel 4**

First Intel 4 P-core (Redwood Cove)  
& E-core (Crestmont)



Leap ahead on **graphics**

Up to 2x GFX performance/watt\*



Deliver **AI at Scale**

First client integration of AI engine  
(NPU)

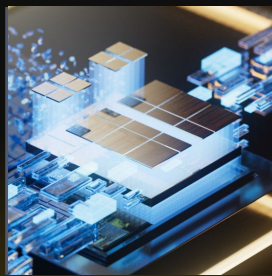


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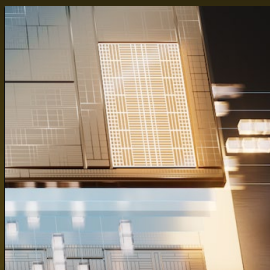


# Meteor Lake

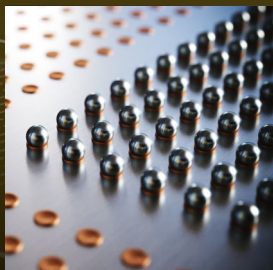
New **P-core & E-core**  
microarchitectures



**3D Performance  
Hybrid  
Architecture**



Built-In  
**NPU AI  
Engine**

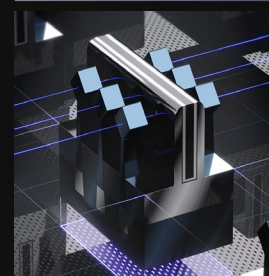


**FOVEROS  
3D  
packaging**

Latest **Media  
& Display**  
Standards



Thunderbolt 4



WiFi 7

Low  
Power  
Island  
E-cores

First on  
**Intel 4**

intel  
**ARC**<sup>™</sup>

Power efficiency  
& AI at scale

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Performance varies by use, configuration and other factors. Learn more at [www.intel.com/PerformanceIndex](http://www.intel.com/PerformanceIndex).

Performance results are based on testing as of dates shown in configurations and may not reflect all publicly available updates. See backup for configuration details.

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